



DOCKET NO.: 212462US0RD

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231



Re: Serial No.: 09/964,581
Applicants: Ymiko OYASATO et al
Filing Date: September 28, 2001
For: METHOD OF COMPOSING THERMOSETTING
RESIN, APPARATUS AND HEAT CONTROL
PROGRAM
GAU: 3749

SIR:

Attached hereto for filing are the following papers:

SUPPLEMENTAL APPLICATION DATA SHEET (3 PP)

Our check in the amount of \$ 0 is attached covering any required fees. In the event any variance exists between the amount enclosed and the Patent Office charges for filing the above-noted documents, including any fees required under 37 C.F.R. §1.136 for any necessary Extension of Time to make the filing of the attached documents timely, please charge or credit the difference to our Deposit Account No. 15-0030. Further, if these papers are not considered timely filed, then a petition is hereby made under 37 C.F.R. §1.136 for the necessary extension of time. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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